Ultra-Low Resistance Dual SPDT Analog Switch

The NS5A4684S is an advanced CMOS analog switch fabricated in Sub-micron silicon gate CMOS technology. The device is a dual Independent Single Pole Double Throw (SPDT) switch featuring Ultra-Low R_{ON} of 0.6 Ω .

The part also features guaranteed Break Before Make (BBM) switching, assuring the switches never short the driver.

Features

- Ultra–Low R_{ON} of 0.6 Ω Max
- Interfaces with 2.8 V Chipset
- Single Supply Operation from 1.65–5.5 V
- Full 0–V_{CC} Signal Handling Capability
- High Isolation; -68 dB at 100 kHz
- Low Standby Current, <50 nA
- Low Distortion; < 0.08% THD
- Low Crosstalk; < -70 dB at 100 kHz
- High Continuous Current Capability
 - \pm 300 mA Through Each Switch
- Large Current Clamping Diodes at Analog Inputs ± 300 mA Continuous Current Capability
- Package:
 - 1.4 x 1.8 x 0.75 mm WQFN10 Package
- This is a Pb–Free Device

Applications

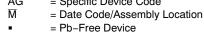
- Cell Phone Audio Block
- Speaker and Earphone Switching
- Ring–Tone Chip / Amplifier Switching
- Modems



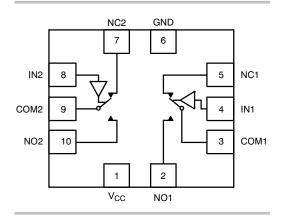
ON Semiconductor®

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(Note: Microdot may be in either location)



FUNCTION TABLE

IN 1, 2	NO 1, 2	NC 1, 2
0	OFF	ON
1	ON	OFF

ORDERING INFORMATION

See detailed ordering and shipping information in the package dimensions section on page 7 of this data sheet.

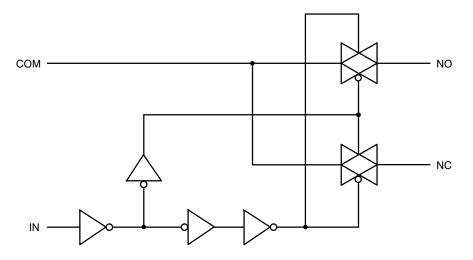


Figure 1. Logic Equivalent Circuit

PIN DESCRIPTION

QFN PIN #	Symbol	Name and Function
2, 5, 7, 10	NC1 to NC2, NO1 to NO2	Independent Channels
4, 8	IN1 and IN2	Controls
3, 9	COM1 and COM2	Common Channels
6	GND	Ground (V)
1	V _{CC}	Positive Supply Voltage

MAXIMUM RATINGS

Symbol	Parameter	Value	Unit
V _{CC}	Positive DC Supply Voltage	–0.5 to +6.5	V
V _{IS}	Analog Input Voltage (V _{NO} , V _{NC} , or V _{COM})	$-0.5 \le V_{IS} \le V_{CC} + 0.5$	V
V _{IN}	Digital Select Input Voltage	$-0.5 \le V_{\text{IN}} \le +5.5$	V
I _{anl1}	Continuous DC Current from COM to NC/NO	±300	mA
I _{anl-pk1}	Peak Current from COM to NC/NO, 10 Duty Cycle (Note 1)	±500	mA
I _{clmp}	Continuous DC Current into COM/NO/NC with Respect to V_{CC} or GND	±100	mA

Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability. 1. Defined as 10% ON, 90% OFF Duty Cycle.

RECOMMENDED OPERATING CONDITIONS

Symbol	Parameter	Min	Мах	Unit
V _{CC}	DC Supply Voltage	1.65	5.5	V
V _{IN}	Digital Select Input Voltage (OVT) Overvoltage Tolerance	GND	5.5	V
V _{IS}	Analog Input Voltage (NC, NO, COM)	GND	V _{CC}	V
T _A	Operating Temperature Range	-40	+85	°C
t _r , t _f	Input Rise or Fall Time, SELECT $V_{CC} = 1.6 \text{ V} - 2.7 \text{ V} \\ V_{CC} = 3.0 \text{ V} - 5.0 \text{ V}$		20 10	ns/V

DC CHARACTERISTICS - DIGITAL SECTION (Voltages Referenced to GND)

				Guai	anteed Limit	
Symbol	Parameter	Condition	V _{cc}	25°C	–40°C to +85°C	Unit
V _{IH}	Minimum High-Level Input Voltage, Select Inputs		3.0 5.0	1.4 2.4	1.4 2.4	V
V _{IL}	Maximum Low-Level Input Voltage, Select Inputs		3.0 5.0	0.7 0.8	0.7 0.8	V
I _{IN}	Maximum Input Leakage Current, Select Inputs	V _{IN} = V _{CC} or GND	5.0	±0.1	±1.0	μΑ
I _{OFF}	Power Off Leakage Current	V _{IN} = V _{CC} or GND	0	±0.5	±2.0	μA
I _{CC}	Maximum Quiescent Supply Current (Note 2)	Select and $V_{IS} = V_{CC}$ or GND	1.65 to 5.0	±1.0	±2.0	μΑ

2. Guaranteed by design. Resistance measurements do not include test circuit or package resistance.

DC ELECTRICAL CHARACTERISTICS - ANALOG SECTION

				Gua	ranteed	Maximun	n Limit	
				25	°C	–40°C to	o +85°C	1
Symbol	Parameter	Condition	v _{cc}	Min	Max	Min	Max	Unit
R _{ON}	NC/NO On-Resistance (Note 3)	$\label{eq:VIN} \begin{array}{l} V_{IN} = V_{IL} \mbox{ or } V_{IN} = V_{IH} \\ V_{IS} = GND \mbox{ to } V_{CC} \\ I_{COM} = 100 \mbox{ mA} \end{array}$	3.0 4.3 5.0		0.55 0.45 0.4		0.6 0.5 0.5	Ω
R _{FLAT}	NC/NO On-Resistance Flatness (Notes 3 and 4)	$I_{COM} = 100 \text{ mA}$ $V_{IS} = 0 \text{ to } V_{CC}$	3.0 4.3 5.0		0.16 0.11 0.11		0.20 0.14 0.14	Ω
ΔR _{ON}	On-Resistance Match Between Channels (Notes 3 and 5)	$\label{eq:VIS} \begin{array}{l} V_{IS} = 1.5 \ V; \\ I_{COM} = 100 \ mA \\ V_{IS} = 2.2 \ V; \\ I_{COM} = 100 \ mA \end{array}$	3.0 4.3 5.0		0.10 0.10 0.10		0.11 0.11 0.11	Ω
I _{NC(OFF)} I _{NO(OFF)}	NC or NO Off Leakage Current (Note 3)	$ \begin{array}{l} V_{IN} = V_{IL} \mbox{ or } V_{IH} \\ V_{NO} \mbox{ or } V_{NC} = 0.3 \ V \\ V_{COM} = \ 4.0 \ V \end{array} $	5.0	-5.0	5.0	-50	50	nA
I _{COM(ON)}	COM ON Leakage Current (Note 3)	$ \begin{array}{l} V_{IN} = V_{IL} \mbox{ or } V_{IH} \\ V_{NO} \mbox{ 0.3 V or } 4.0 \mbox{ V with} \\ V_{NC} \mbox{ floating or } \\ V_{NC} \mbox{ 0.3 V or } 4.0 \mbox{ V with} \\ V_{NO} \mbox{ floating } \\ V_{COM} = \mbox{ 0.3 V or } 4.0 \mbox{ V} \end{array} $	5.0	-10	10	-100	100	nA

 Guaranteed by design. Resistance measurements do not include test circuit or package resistance.
Flatness is defined as the difference between the maximum and minimum value of On-resistance as measured over the specified analog signal ranges. 5. $\Delta R_{ON} = R_{ON(MAX)} - R_{ON(MIN)}$ between NC1 and NC2 or between NO1 and NO2.

AC ELECTRICAL CHARACTERISTICS (Input $t_r = t_f = 3.0 \text{ ns}$)

					G	auarant	teed Ma	aximum L	imit	
			v _{cc}	V _{IS}		25°C		–40°C to	o +85°C	
Symbol	Parameter	Test Conditions	(V)	(V)	Min	Тур*	Max	Min	Мах	Unit
t _{ON}	Turn-On Time	$R_L = 50 \Omega$, $C_L = 35 pF$ (Figures 3 and 4)	2.3 - 5.0	1.5			50		60	ns
t _{OFF}	Turn-Off Time	$R_L = 50 \Omega$, $C_L = 35 pF$ (Figures 3 and 4)	2.3 - 5.0	1.5			30		40	ns
t _{BBM}	Minimum Break-Before-Make Time		3.0	1.5	2	15				ns

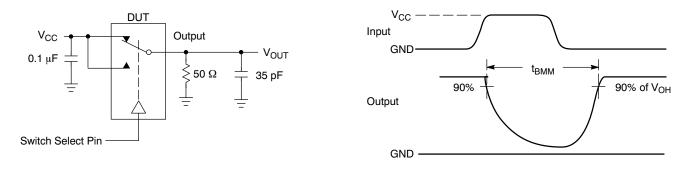
		Typical @ 25, V _{CC} = 3.6 V	
C _{IN}	Control Pin Input Capacitance	3.5	pF
C _{NO/NC}	NO, NC Port Capacitance	60	pF
C _{COM}	COM Port Capacitance When Switch is Enabled	200	pF

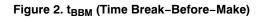
*Typical Characteristics are at 25°C.

ADDITIONAL APPLICATION CHARACTERISTICS (Voltages Referenced to GND Unless Noted)

			V _{cc}	25°C	
Symbol	Parameter	Condition	(V)	Typical	Unit
BW	Maximum On-Channel -3 dB Bandwidth or Minimum Frequency Response	V _{IN} centered between V _{CC} and GND (Figure 5)	1.65 – 5.0	19	MHz
V _{ONL}	Maximum Feed-through On Loss	V_{IN} = 0 dBm @ 100 kHz to 50 MHz V_{IN} centered between V_{CC} and GND (Figure 5)	1.65 – 5.0	-0.06	dB
V _{ISO}	Off-Channel Isolation	f = 100 kHz; V_{IS} = 1 V RMS; C_L = 5.0 pF V_{IN} centered between V_{CC} and GND (Figure 5)	1.65 – 5.0	-68	dB
Q	Charge Injection Select Input to Common I/O	$V_{IN} = V_{CC to} \text{ GND}, \text{ R}_{IS} = 0 \Omega, \text{ C}_{L} = 1.0 \text{ nF}$ Q = C _L x DV _{OUT} (Figure 6)	1.65 – 5.0	38	рС
THD	Total Harmonic Distortion THD + Noise	F_{IS} = 20 Hz to 20 kHz, R_L = R_{gen} = 600 $\Omega,$ C_L = 50 pF V_{IS} = 2.0 V RMS	3.0	0.08	%
VCT	Channel-to-Channel Crosstalk	f = 100 kHz; V _{IS} = 1.0 V RMS, C _L = 5.0 pF, R _L = 50 Ω V _{IN} centered between V _{CC} and GND (Figure 5)	1.65 – 5.0	-70	dB

6. Off-Channel Isolation = 20log10 (V_{COM}/V_{NO}), V_{COM} = output, V_{NO} = input to off switch.





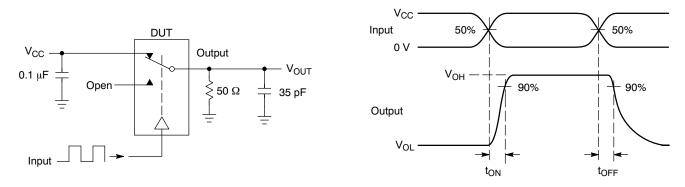
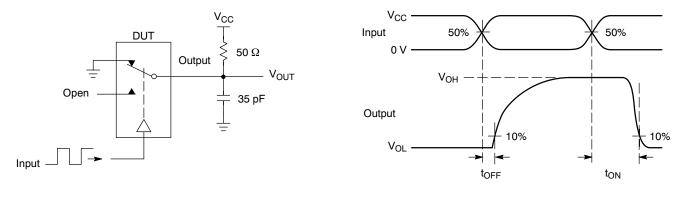
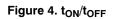
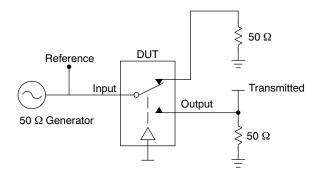


Figure 3. t_{ON}/t_{OFF}



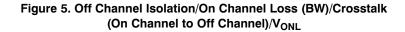




Channel switch control/s test socket is normalized. Off isolation is measured across an off channel. On loss is the bandwidth of an On switch. V_{ISO} , Bandwidth and V_{ONL} are independent of the input signal direction.

$$\begin{split} V_{ISO} &= \text{Off Channel Isolation} = 20 \ \text{Log}\Big(\frac{V_{OUT}}{V_{IN}}\Big) \text{for } V_{IN} \text{ at } 100 \ \text{kHz} \\ V_{ONL} &= \text{On Channel Loss} = 20 \ \text{Log}\Big(\frac{V_{OUT}}{V_{IN}}\Big) \text{ for } V_{IN} \text{ at } 100 \ \text{kHz} \text{ to } 50 \ \text{MHz} \end{split}$$

Bandwidth (BW) = the frequency 3 dB below V_{ONL} V_{CT} = Use V_{ISO} setup and test to all other switch analog input/outputs terminated with 50 Ω



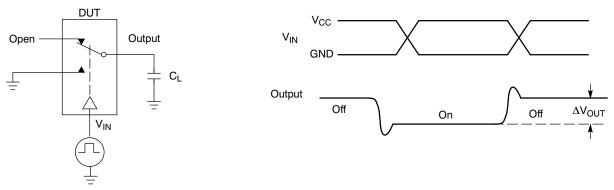


Figure 6. Charge Injection: (Q)

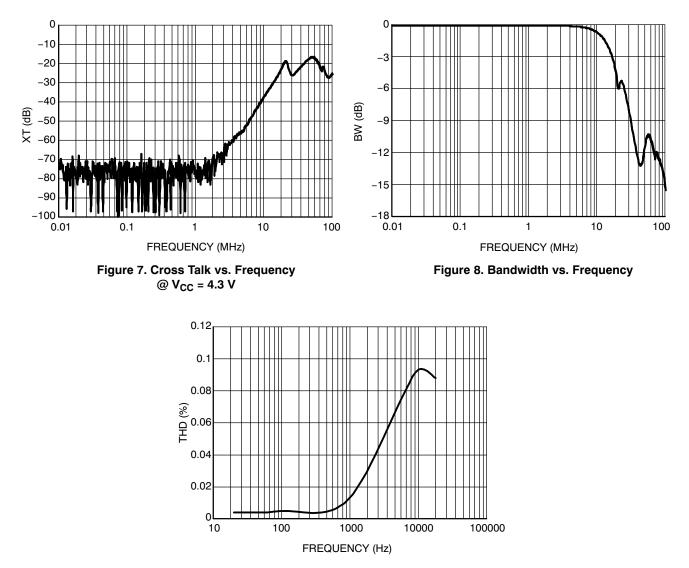


Figure 9. Total Harmonic Distortion

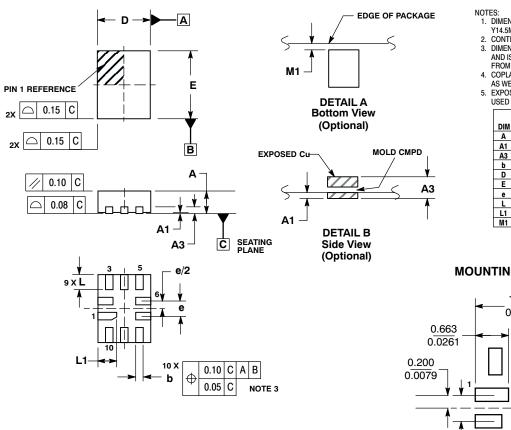
ORDERING INFORMATION

Device	Package	Shipping [†]
NS5A4684SMNTAG	WQFN10 (Pb-Free)	3000 / Tape & Reel
NS5A4684SMNTBG	WQFN10 (Pb-Free)	3000 / Tape & Reel

†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

PACKAGE DIMENSIONS

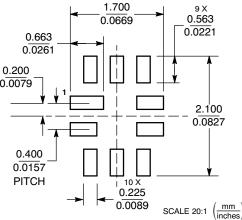
WQFN10, 1.4x1.8, 0.4P CASE 488AQ ISSUE C



- DIMENSIONING AND TOLERANCING PER ASME Y14.5M. 1994.
- CONTROLLING DIMENSION: MILLIMETERS DIMENSION b APPLIES TO PLATED TERMINAL AND IS MEASURED BETWEEN 0.25 AND 0.30 MM FROM TERMINAL.
- COPLANARITY APPLIES TO THE EXPOSED PAD AS WELL AS THE TERMINALS. EXPOSED PADS CONNECTED TO DIE FLAG.
- USED AS TEST CONTACTS.

	MILLIN	IETERS
DIM	MIN	MAX
Α	0.70	0.80
A1	0.00	0.050
A3	0.20	REF
b	0.15	0.25
D	1.40	BSC
Е	1.80	BSC
е	0.40	BSC
L	0.30	0.50
L1	0.40	0.60
M1	0.00	0.05

MOUNTING FOOTPRINT



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